



晶体管光耦

Photo Transistor

QX127E

宁波群芯微电子股份有限公司

NINGBO QUNXIN MICROELECTRONICS CO., LTD.

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概述 Description

QX127E是一款由发光二极管和光电晶体管组成的光电耦合器。四引脚封装。

The QX127E is a photoelectric coupler composed of light-emitting diode and phototransistor. It is packaged in a 4-pin package.

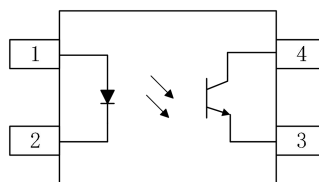
特性 Features

- 电流转换比(CTR)范围: $\geq 20\%$ ($I_F=5\text{mA}$, $V_{CE}=5\text{V}$, $T_A=25^\circ\text{C}$)
Current transfer ratio: $\geq 20\%$ ($I_F=5\text{mA}$, $V_{CE}=5\text{V}$, $T_A=25^\circ\text{C}$)
- 输入-输出隔离电压 ($V_{ISO}=3750\text{ V}_{\text{rms}}$)
High isolation voltage between input and output($V_{ISO}=3750\text{ V}_{\text{rms}}$)
- 集电极-发射极击穿电压 $BV_{CEO}\geq 75\text{V}$
Collector-emitter breakdown voltage $BV_{CEO}\geq 75\text{V}$
- AEC-Q101 合格
AEC-Q101 qualified
- 工作温度: $-40^\circ\text{C}\sim +125^\circ\text{C}$
Operating Temperature: $-40^\circ\text{C}\sim +125^\circ\text{C}$
- 符合加强绝缘标准
Meet reinforced insulation standards
- 符合安规标准 Safety standards approval:
—VDE DIN EN60747-5-5 (VDE 0884-5) (CERTIFICATE NO UL-US-2128013-2)
—UL 1577 (CERTIFICATE NO 40053982)
—CQC 11-471543-2022 (CERTIFICATE NO CQC20001274613)

应用 Applications

- DC-DC 转换器
DC-DC converter
- 通讯设备
Communications equipment
- 可编程控制器
Programmable controller
- 信号传输
Signal transmission

封装和原理图 Package and Schematic Diagram



Pin Configuration

1. Anode
2. Cathode
3. Emitter
4. Collector



产品型号命名规则 Order Code

QX 127E - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦

- ① 公司代码 Company Code (QX: 群芯 Qunxin)
- ② 产品系列 Product Series (127E: 127E)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (S: SOP)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or None)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中“”为群芯品牌 LOGO
“”denotes LOGO
- 印字中“Y”代表年份; A(2018), B(2019), C(2020).....
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号
“WW”denotes Week's number
- 印字中“N”代表星期几
“N”denotes the day of the week
- 印字中的“H”代表无卤
“H”denotes Halogen-free



绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	≥5.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body.
电气间隙 Clearance Distance	L	≥5.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air.
绝缘距离 Insulation Thickness	DTI	≥0.3	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector.
峰值隔离电压 Peak Isolation Voltage	V_{IORM}	600	V_{peak}	IEC/EN/DIN EN60747-5-5.
瞬态隔离电压 Transient Isolation Voltage	V_{IOTM}	5000	V_{peak}	IEC/EN/DIN EN60747-5-5.
隔离电压 Isolation Voltage	V_{ISO}	> 3750	V_{rms}	For 1 minute

极限参数 Absolute Maximum Ratings ($T_A=25^{\circ}C$)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	I_F	20	mA
	反向电压 Reverse Voltage	V_R	6	V
	功耗 Power Dissipation	P_D	70	mW
接收端 Output	集电极功耗 Collector Power Dissipation	P_C	150	mW
	集电极电流 Collector Current	I_C	50	mA
	集电极-发射极电压 Collector-Emitter Voltage	V_{CEO}	75	V
	发射极-集电极电压 Emitter-Collector Voltage	V_{ECO}	7	V
总功耗 Total Power Dissipation		P_{tot}	150	mW
隔离电压 Isolation Voltage		V_{ISO}	3750	V_{rms}
工作温度 Operating Temperature		T_{opr}	-40~+125	$^{\circ}C$
存储温度 Storage Temperature		T_{stg}	-55~+150	$^{\circ}C$
焊接温度 Soldering Temperature		T_{sol}	260	$^{\circ}C$

产品特性参数 Electro-optical Characteristics ($T_A=25^\circ\text{C}$)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage	V_F	$I_F=1\text{mA}$	1.0	1.35	1.8	V
	反向电流 Reverse Current	I_R	$V_R=6\text{V}$	-	-	10	μA
	输入电容 Terminal Capacitance	C_t	$V=0, f=1\text{kHz}$	-	30	-	pF
接收端 Output	集电极暗电流 Collector Dark Current	I_{CEO}	$V_{CE}=75\text{V}$	-	-	100	nA
	集电极-发射极击穿电压 Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C=0.5\text{mA}, I_F=0$	75	130	-	V
	发射极-集电极击穿电压 Emitter-Collector Breakdown Voltage	BV_{ECO}	$I_E=0.1\text{mA}, I_F=0$	7	12	-	V
传输特性 Transfer Characteristics	电流传输比 Current Transfer Ratio	CTR^*	$I_F=5\text{mA}, V_{CE}=5\text{V}$	220	-	400	%
	集电极-发射极饱和压降 Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F=20\text{mA}, I_C=1\text{mA}$	-	0.1	0.2	V
	隔离电阻 Isolation Resistance	R_{ISO}	DC500V, 40~60%R.H.	5×10^{10}	1×10^{11}	-	Ω
	隔离电容 Isolation Capacitance	C_{ISO}	$V=0, f=1\text{MHz}$	-	0.3	1.5	pF
	开启时间 Turn On Time	T_{on}	$I_F=1.6\text{mA}$ $V_{CC}=5\text{V}$ $R_L=0.75\text{k}\Omega$	-	6	20	μs
	关断时间 Turn Off Time	T_{off}		-	6	20	μs
	上升时间 Rise Time	T_r		-	5	-	μs
下降时间 Fall Time	T_f	-		5.5	-	μs	

注*：电流传输比= $I_C/I_F \times 100\%$ 。

Note*：CTR= $I_C/I_F \times 100\%$ 。

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 Relative Current Transfer Ratio vs. Forward Current

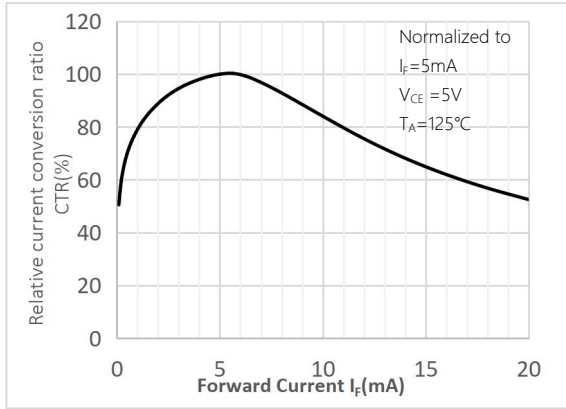


Fig.2 Forward Current vs. Forward Voltage

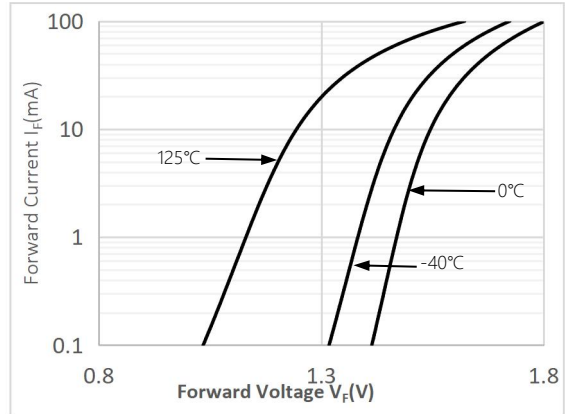


Fig.3 Collector Current vs. Collector-Emitter Voltage

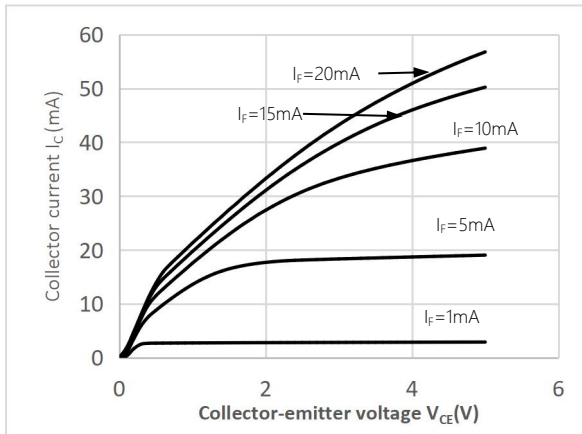


Fig.4 Relative Current Transfer Ratio vs. Ambient Temperature

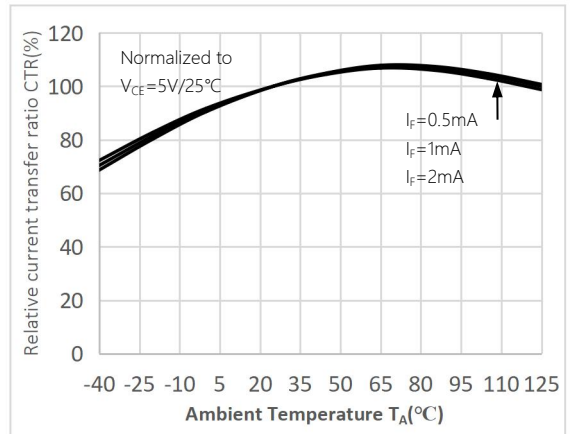


Fig.5 Collector-Emitter Saturation Voltage vs. Ambient Temperature

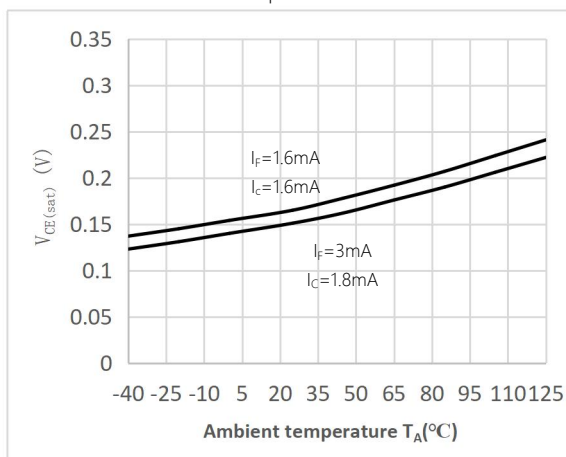


Fig.6 Collector Dark Current vs. Ambient Temperature

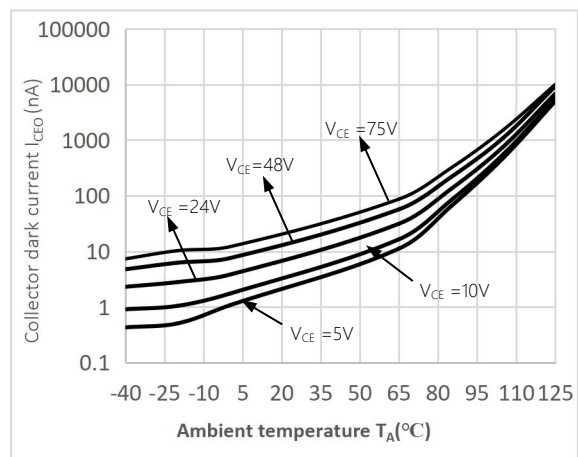


Fig.7 Response Time vs. Load Resistance

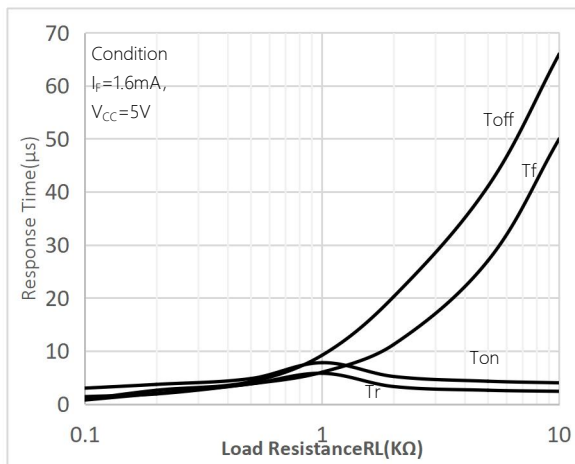


Fig.8 Collector Current vs. Ambient Temperature

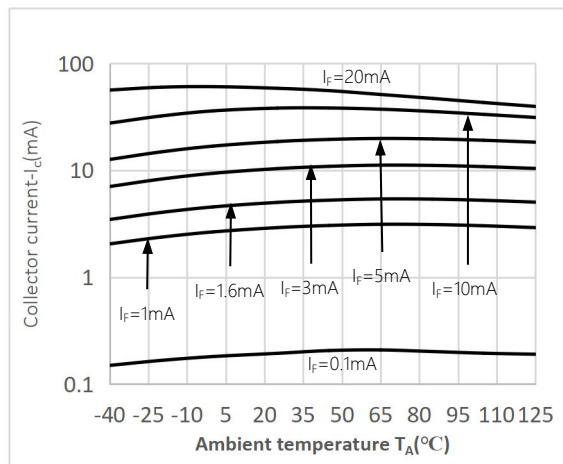
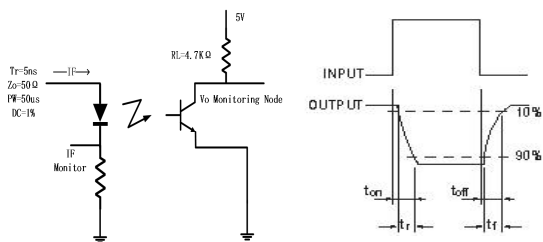
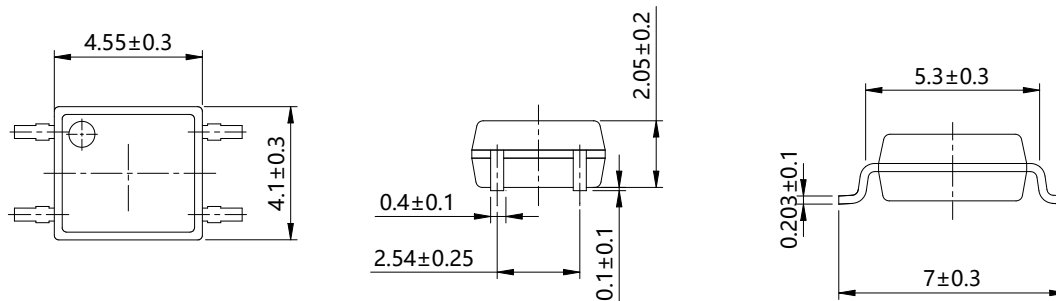


Fig.9 Switching Time Test Circuit & Waveforms



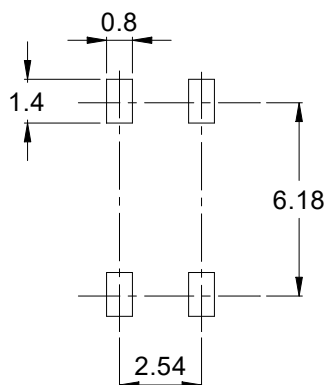
外形尺寸 Outline Dimensions

SOP4



单位 Unit: mm

建议焊盘布局 Recommended Pad Layout

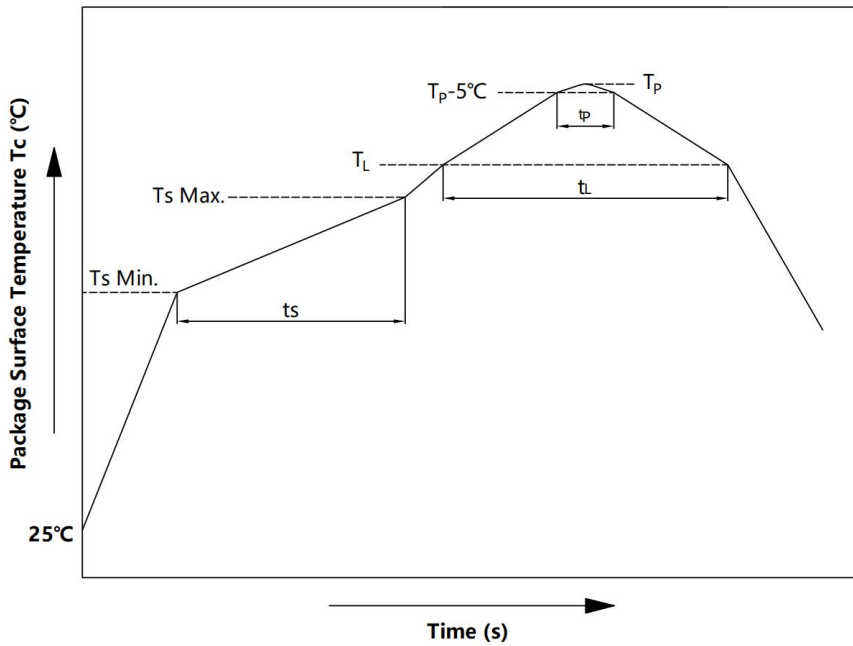


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 Solder Reflow Profile

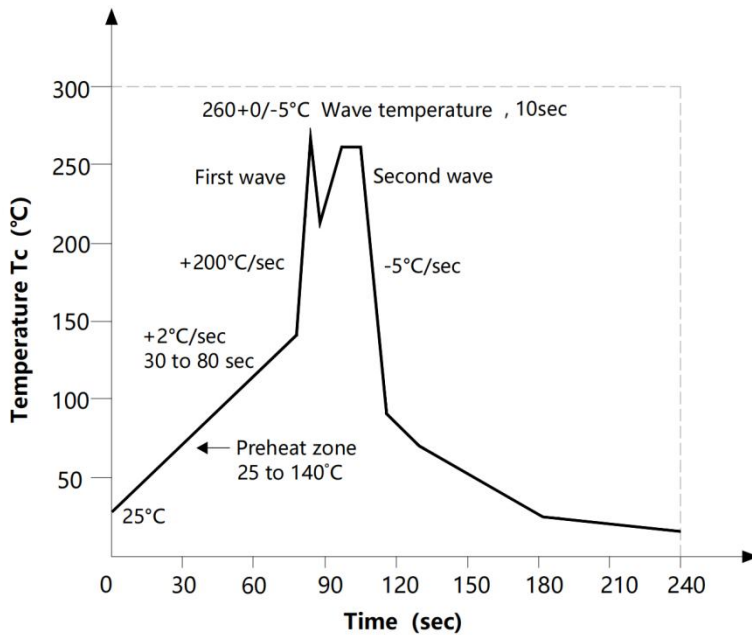


项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	T_s	150	200	$^\circ\text{C}$
预热时间 Preheat Time	t_s	60	120	s
升温速率 Ramp-Up Rate (T_L to T_P)	-	-	3	$^\circ\text{C}/\text{s}$
液相线温度 Liquidus Temperature	T_L	217		$^\circ\text{C}$
时间高于 T_L Time Above T_L	t_L	60	150	s
峰值温度 Peak Temperature	T_P	-	260	$^\circ\text{C}$
T_c 在 $(T_P - 5)$ 和 T_P 之间的时间 Time During Which T_c Is Between $(T_P - 5)$ and T_P	t_p	-	30	s
降温速率 Ramp-down Rate (T_P to T_L)	-	-	6	$^\circ\text{C}/\text{s}$

注：建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；

Note: Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

- A. 手工烙铁焊仅用于产品返修或样品测试;
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求: 温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$ 。
Hand soldering iron requirements: Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

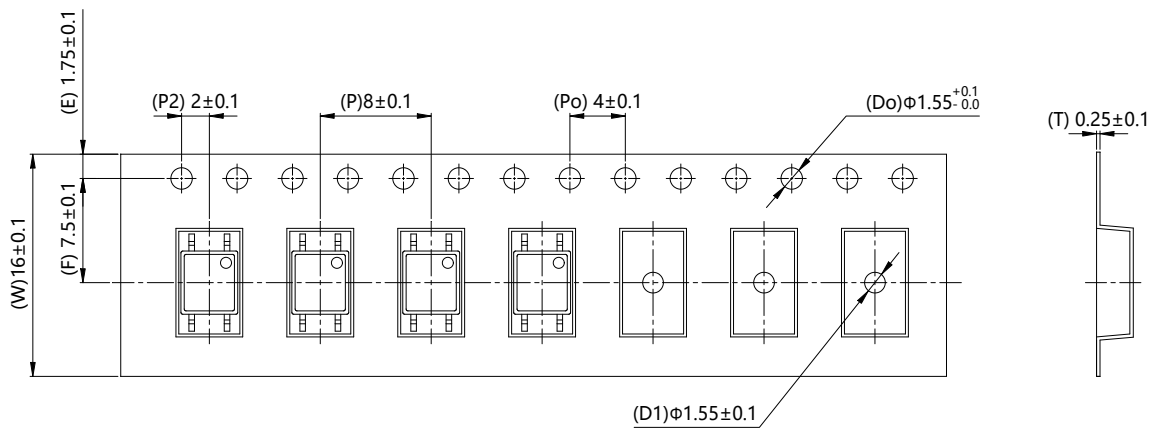
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SOP4	卷盘 (φ330mm 蓝盘)	3000 只/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	34*6*34cm	38*36*36.5cm	首端各空 50 个空格, 末端空 100
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP4	Reel (φ330mm Blue)	3000 pcs /reel	2 reels /box	10 boxes /ctn	450*390*0.1mm	34*6*34cm	38*36*36.5cm	Leave 50 Spaces at the beginning and 100 Spaces at the end

■ 编带包装 Tape & Reel

- 1) 每卷数量: 3000 只。
Qty/reel: 3000 pcs.
- 2) 每箱数量: 60000 只。
Qty/ctn: 60000 pcs.
- 3) 内包装: 每盒 2 盘。
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



单位 Unit: mm

注意 Attention

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